

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM}	60	٧
Average Rectified Output Current	lo	3	Α
Non-Repetitive Avalanche Energy (T _J = +25°C, I _{AS} = 2A, L = 50mH)	E _{AS}	120	mJ
Non-Repetitive Peak Forward Surge Current 8.3ms	I _{FSM}	80	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance (Note 7)	$R_{\theta JA}$	95	°C/W
Typical Thermal Resistance (Note 8)	R _{0JA}	35	°C/W
Typical Thermal Resistance (Note 7)	$R_{ heta JC}$	15	°C/W
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +175	°C

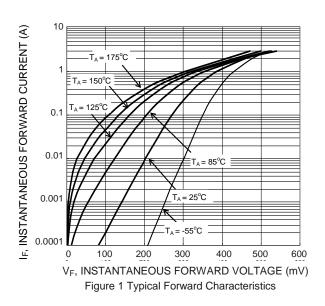
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	V _F	_	0.43		V	I _F =1.5A, T _J = +25°C
		_	0.53	0.60		$I_F = 3.0A$, $T_J = +25$ °C
		_	0.40	_		I _F =1.5A, T _J = +125°C
		_	0.52	_		I _F =3.0A, T _J = +125°C
Lookaga Current (Note O)	I _R	_	0.009	0.06	mΑ	$V_R = 60V, T_J = +25^{\circ}C$
Leakage Current (Note 9)		_	2.7	15		$V_R = 60V, T_J = +125$ °C
Total Capacitance	Ст	_	110		pF	$V_R = 4V, T_J = +25^{\circ}C, f = 1MHz$

Notes: 7. Device mounted on FR-4 PCB, 2oz. copper, minimum recommended pad layout per http://www.diodes.com/package-outlines.html.

8. Device mounted on 2 inch x 2 inch Al board.

9. Short duration pulse test used to minimize self-heating effect.



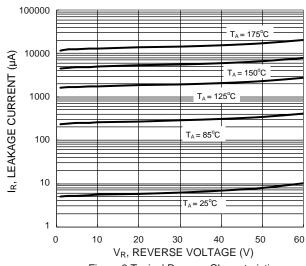
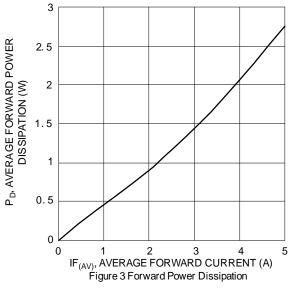
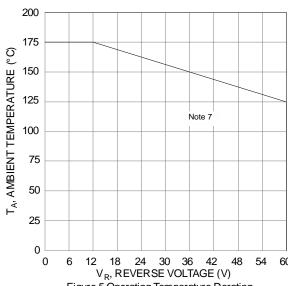
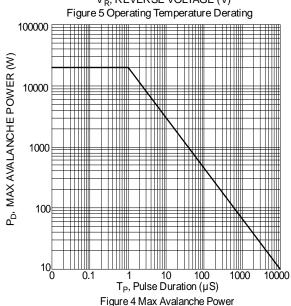


Figure 2 Typical Reverse Characteristics

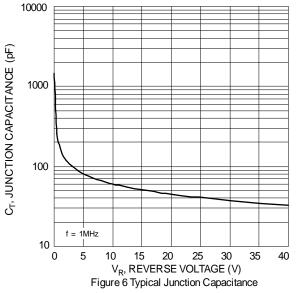








2.5 Note 8 Note

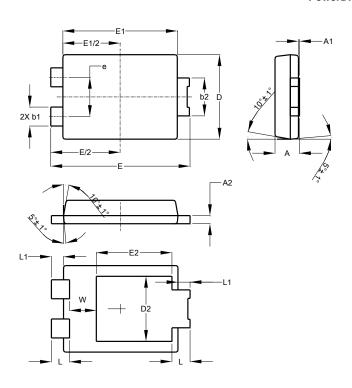




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5

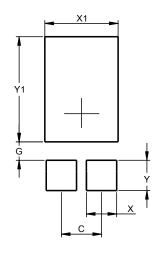


PowerDI5				
Dim	Min	Max	Тур	
Α	1.05	1.15	1.10	
A1	0.00	0.05		
A2	0.33	0.43	0.381	
b1	0.80	0.99	0.89	
b2	1.70	1.88	1.78	
D	3.90	4.05	3.966	
D2		-	3.054	
Е	6.40	6.60	6.504	
е			1.84	
E1	5.30	5.45	5.37	
E2			3.549	
L	0.75	0.95	0.85	
L1	0.50	0.65	0.57	
W	1.10	1.41	1.255	
All Dimensions in mm				

Suggested Pad Layout

 $\label{please} Please see \ http://www.diodes.com/package-outlines.html for the latest version.$

PowerDI5



Dimensions	Value (in mm)
С	1.840
G	0.852
X	1.390
X1	3.360
Y	1.400
Y1	4 860



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